BSH103,235 Datasheet

https://www.DiGi-Electronics.com

DiGi Electronics Part Number	BSH103,235-DG
Manufacturer	Nexperia USA Inc.
Manufacturer Product Number	BSH103,235
Description	MOSFET N-CH 30V 850MA TO236AB
Detailed Description	N-Channel 30 V 850mA (Ta) 540mW (Ta) Surface Mount TO-236AB

Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

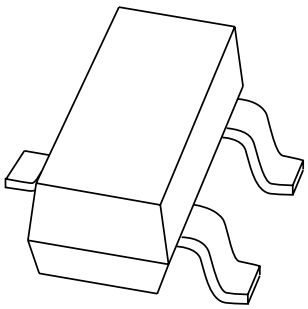
Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
BSH103,235	Nexperia USA Inc.
Series:	Product Status:
-	Not For New Designs
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
30 V	850mA (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
2.5V	400mOhm @ 500mA, 4.5V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
400mV @ 1mA (Min)	2.1 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±8V	83 pF @ 24 V
FET Feature:	Power Dissipation (Max):
-	540mW (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
TO-236AB	TO-236-3, SC-59, SOT-23-3
Base Product Number:	
BSH103	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.21.0095	

DATA SHEET



BSH103
N-channel enhancement mode MOS transistor

Product specification
Supersedes data of 1998 Jan 30
File under Discrete Semiconductors, SC13b

1998 Feb 11

Philips Semiconductors

N-channel enhancement mode MOS transistor

BSH103

FEATURES

- Very low threshold
- High-speed switching
- No secondary breakdown
- Direct interface to C-MOS, TTL etc.

APPLICATIONS

- Power management
- DC to DC converters
- Battery powered applications
- 'Glue-logic'; interface between logic blocks and/or periphery
- General purpose switch.

DESCRIPTION

N-channel enhancement mode MOS transistor in a SOT23 SMD package.

PINNING - SOT23

PIN	SYMBOL	DESCRIPTION
1	g	gate
2	s	source
3	d	drain

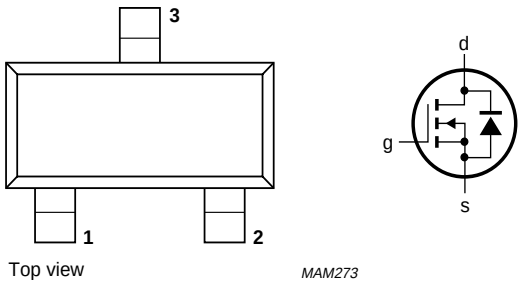


Fig.1 Simplified outline and symbol.

QUICK REFERENCE DATA

SYMBOL	PARAMETERS	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		–	30	V
V_{SD}	source-drain diode forward voltage	V_{GD} = 0; I_S = 0.5 A	–	1	V
V_{GS}	gate-source voltage (DC)		–	±8	V
V_{GSth}	gate-source threshold voltage	V_{DS} = V_{GS}; I_D = 1 mA	0.4	–	V
I_D	drain current (DC)	T_s = 80 °C	–	0.85	A
R_{DSon}	drain-source on-state resistance	V_{GS} = 2.5 V; I_D = 0.5 A	–	0.5	Ω
P_{tot}	total power dissipation	T_s = 80 °C	–	0.5	W

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		–	30	V
V_{GS}	gate-source voltage (DC)		–	±8	V
I_D	drain current (DC)	T_s = 80 °C; note 1	–	0.85	A
I_{DM}	peak drain current	note 2	–	3.4	A
P_{tot}	total power dissipation	T_s = 80 °C	–	0.5	W
		T_{amb} = 25 °C; note 3	–	0.75	W
		T_{amb} = 25 °C; note 4	–	0.54	W
T_{stg}	storage temperature		–55	+150	°C
T_j	operating junction temperature		–55	+150	°C
Source-drain diode					
I_S	source current (DC)	T_s = 80 °C	–	0.5	A
I_{SM}	peak pulsed source current	note 2	–	2	A

Notes

1. T_s is the temperature at the soldering point of the drain lead.
2. Pulse width and duty cycle limited by maximum junction temperature.
3. Device mounted on printed-circuit board with an $R_{th\ a\text{-}tp}$ (ambient to tie-point) of 27.5 K/W.
4. Device mounted on printed-circuit board with an $R_{th\ a\text{-}tp}$ (ambient to tie-point) of 90 K/W.

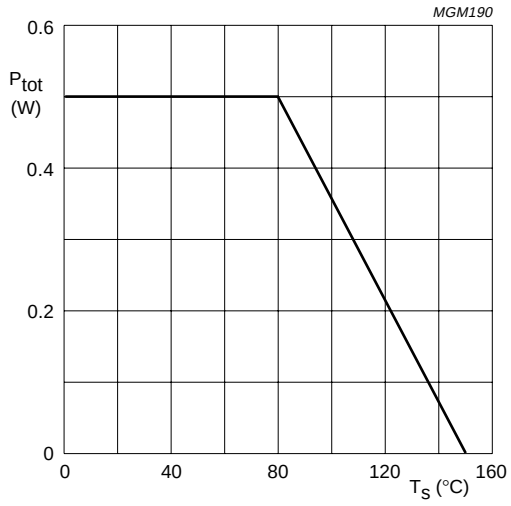
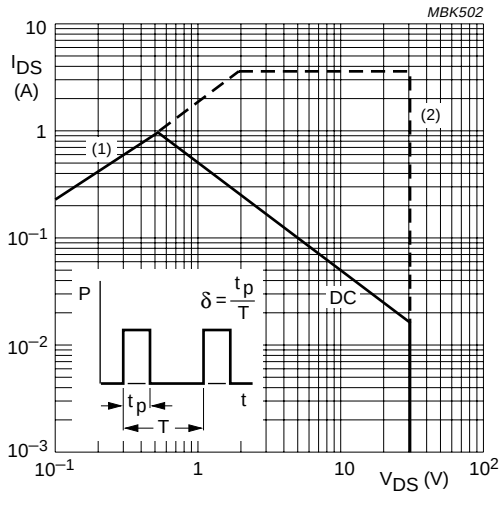


Fig.2 Power derating curve.



δ = 0.01; T_s = 80 °C.
(1) R_{DSon} limitation.
(2) Pulsed.

Fig.3 SOAR.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j\text{-}s}$	thermal resistance from junction to soldering point	140	K/W

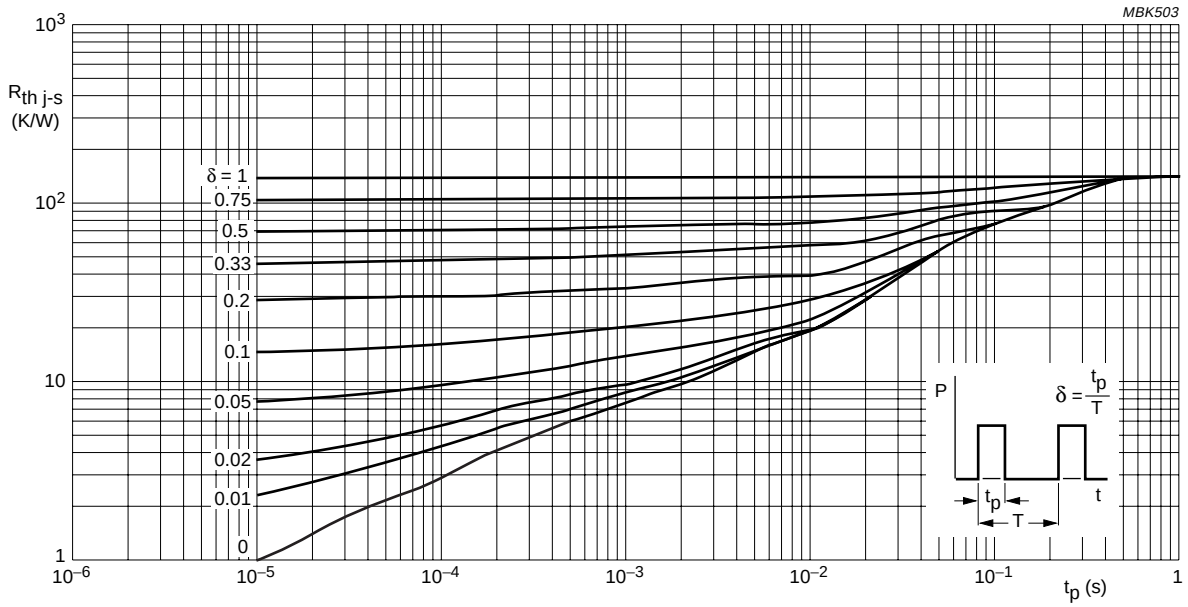


Fig.4 Transient thermal resistance from junction to soldering point as a function of pulse time; typical values.

CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0; I_D = 10 μA	30	–	–	V
V_{GSth}	gate-source threshold voltage	V_{GS} = V_{DS}; I_D = 1 mA	0.4	–	–	V
I_{DSS}	drain-source leakage current	V_{GS} = 0; V_{DS} = 24 V	–	–	100	nA
I_{GSS}	gate leakage current	V_{GS} = ±8 V; V_{DS} = 0	–	–	±100	nA
R_{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I_D = 0.5 A	–	–	0.4	Ω
		V_{GS} = 2.5 V; I_D = 0.5 A	–	–	0.5	Ω
		V_{GS} = 1.8 V; I_D = 0.25 A	–	–	0.6	Ω
C_{iss}	input capacitance	V_{GS} = 0; V_{DS} = 24 V; f = 1 MHz	–	83	–	pF
C_{oss}	output capacitance	V_{GS} = 0; V_{DS} = 24 V; f = 1 MHz	–	27	–	pF
C_{rss}	reverse transfer capacitance	V_{GS} = 0; V_{DS} = 24 V; f = 1 MHz	–	14	–	pF
Q_G	total gate charge	V_{GS} = 4.5 V; V_{DD} = 15 V; I_D = 0.5 A; T_{amb} = 25 °C	–	2100	–	pC
Q_{GS}	gate-source charge	V_{DD} = 15 V; I_D = 0.5 A; T_{amb} = 25 °C	–	95	–	pC
Q_{GD}	gate-drain charge	V_{DD} = 15 V; I_D = 0.5 A; T_{amb} = 25 °C	–	670	–	pC
Switching times						
$t_{d(on)}$	turn-on delay time	V_{GS} = 0 to 8 V; V_{DD} = 15 V; I_D = 0.5 A; R_{gen} = 6 Ω	–	2.5	–	ns
t_f	fall time	V_{GS} = 0 to 8 V; V_{DD} = 15 V; I_D = 0.5 A; R_{gen} = 6 Ω	–	3.5	–	ns
t_{on}	turn-on switching time	V_{GS} = 0 to 8 V; V_{DD} = 15 V; I_D = 0.5 A; R_{gen} = 6 Ω	–	6	–	ns
$t_{d(off)}$	turn-off delay time	V_{GS} = 8 to 0 V; V_{DD} = 15 V; I_D = 0.5 A; R_{gen} = 6 Ω	–	20	–	ns
t_r	rise time	V_{GS} = 8 to 0 V; V_{DD} = 15 V; I_D = 0.5 A; R_{gen} = 6 Ω	–	7	–	ns
t_{off}	turn-off switching time	V_{GS} = 8 to 0 V; V_{DD} = 15 V; I_D = 0.5 A; R_{gen} = 6 Ω	–	27	–	ns
Source-drain diode						
V_{SD}	source-drain diode forward voltage	V_{GD} = 0; I_S = 0.5 A	–	–	1	V
t_{rr}	reverse recovery time	I_S = 0.5 A; di/dt = –100 A/μs	–	25	–	ns

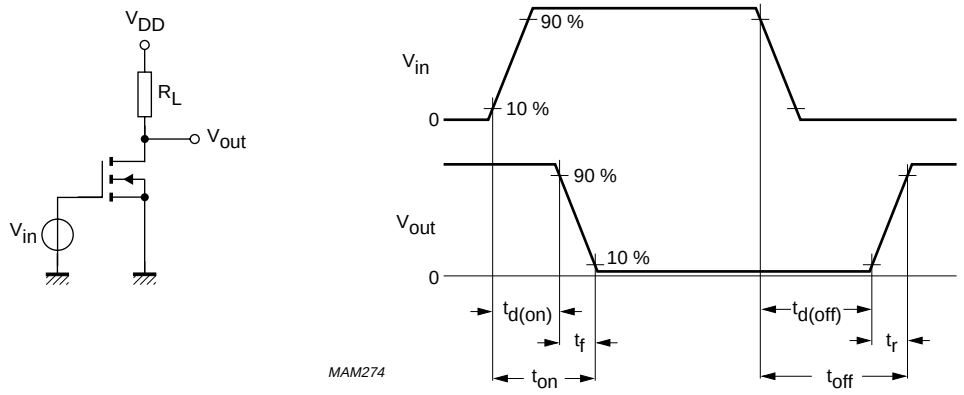
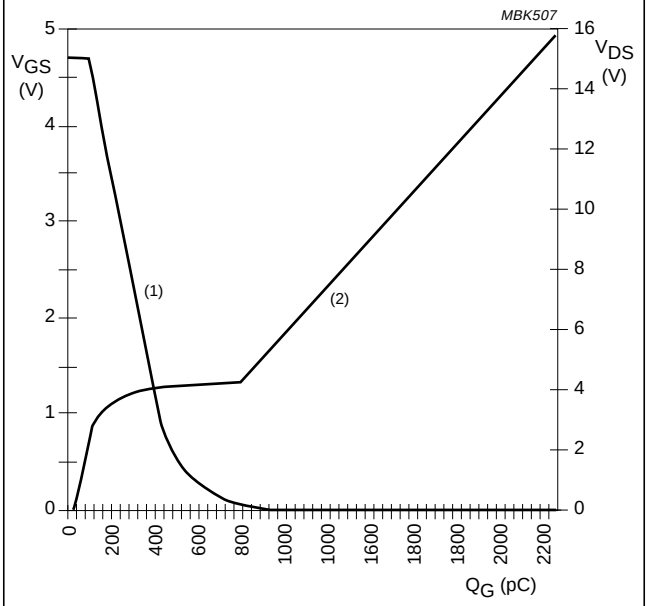
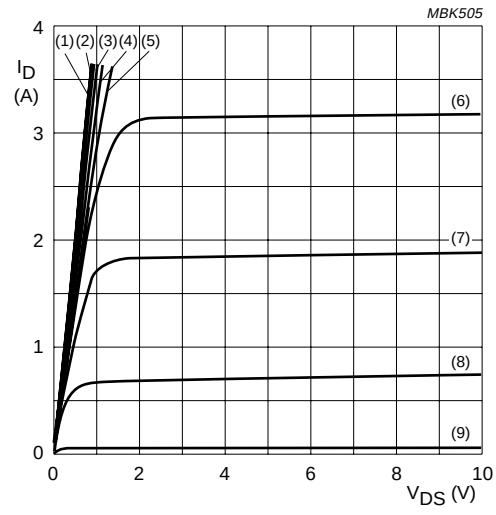


Fig.5 Switching times test circuit with input and output waveforms.



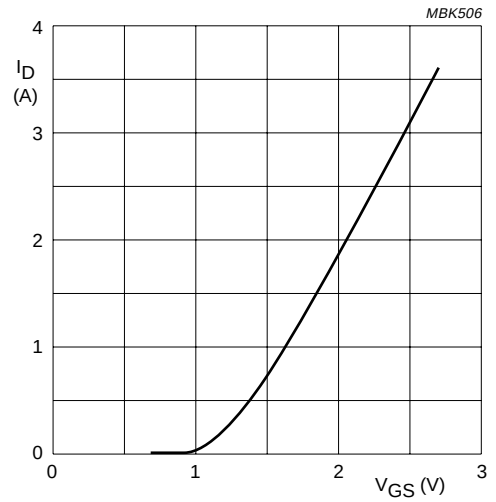
V_{DD} = 15 V; I_D = 0.5 A; T_{amb} = 25 °C.
(1) V_{DS}.
(2) V_{GS}.

Fig.6 Gate-source and drain-source voltages as functions of total gate charge; typical values.



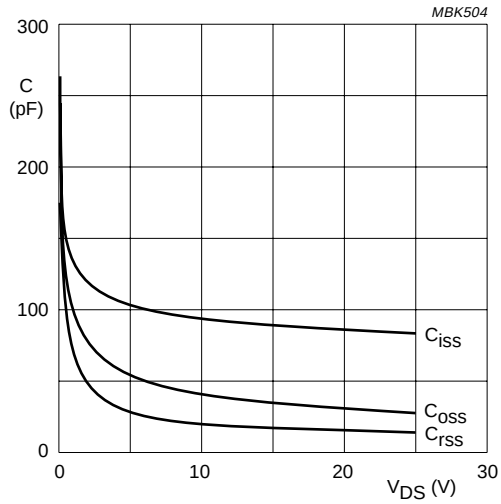
T_{amb} = 25 °C; t_p = 300 µs; δ = 0.
(1) V_{GS} = 7.5 V.
(2) V_{GS} = 5.5 V.
(3) V_{GS} = 4.5 V.
(4) V_{GS} = 3.5 V.
(5) V_{GS} = 3 V.
(6) V_{GS} = 2.5 V.
(7) V_{GS} = 2 V.
(8) V_{GS} = 1.5 V.
(9) V_{GS} = 1 V.

Fig.7 Output characteristics; typical values.



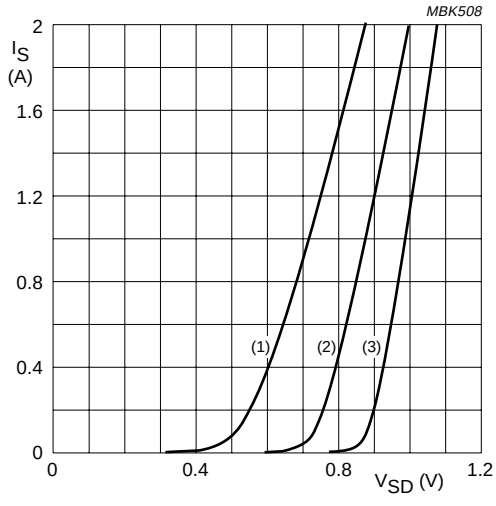
V_{DS} = 10 V; T_{amb} = 25 °C; t_p = 300 µs; δ = 0.

Fig.8 Transfer characteristic; typical values.



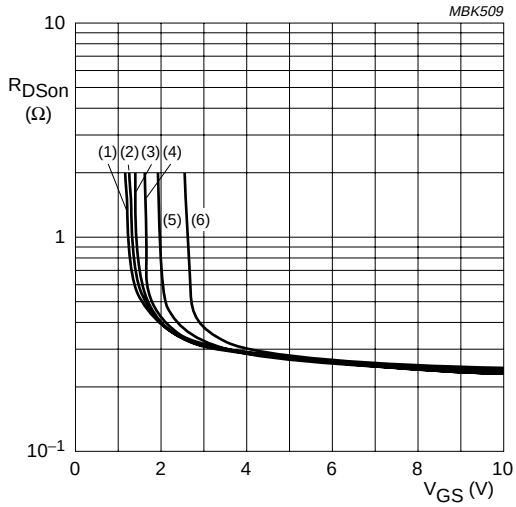
V_{GS} = 0 ; f = 1 MHz; T_{amb} = 25 °C.

Fig.9 Capacitance as a function of drain-source voltage; typical values.



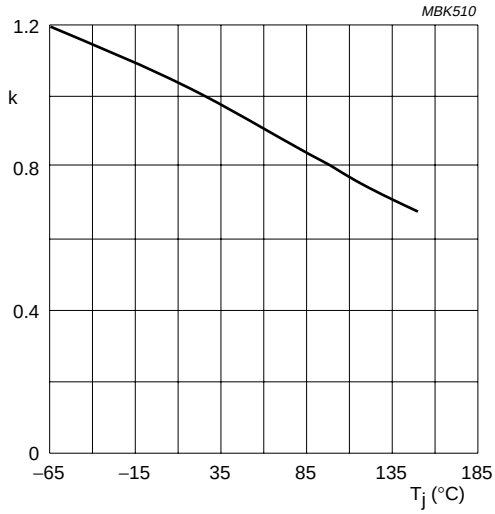
V_{GD} = 0.
(1) T_{amb} = 150 °C.
(2) T_{amb} = 25 °C.
(3) T_{amb} = –65 °C.

Fig.10 Source current as a function of source-drain diode forward voltage; typical values.



T_{amb} = 25 °C; t_p = 300 µs; δ = 0.
(1) I_D = 0.1 A.
(2) I_D = 0.22 A.
(3) I_D = 0.45 A.
(4) I_D = 0.9 A.
(5) I_D = 1.8 A.
(6) I_D = 3.6 A.

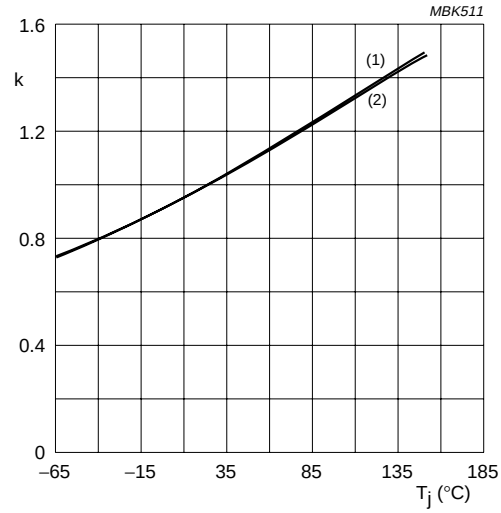
Fig.11 Drain-source on-state resistance as a function of gate-source voltage; typical values.



$k = \frac{V_{GSth} \text{ at } T_j}{V_{GSth} \text{ at } 25°C}$.

V_{GSth} at $V_{DS} = V_{GS}$; I_D = 1 mA.

Fig.12 Temperature coefficient of gate-source threshold voltage as a function of junction temperature; typical values.



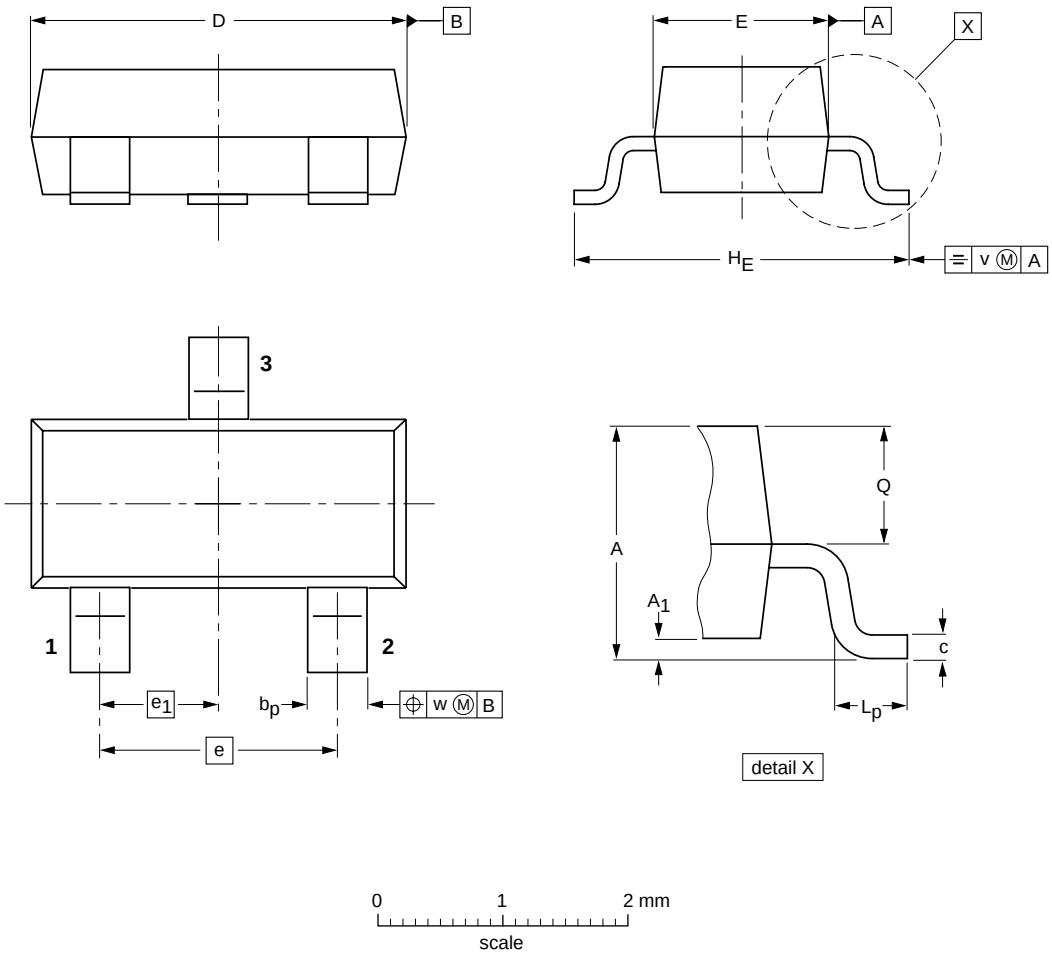
$k = \frac{R_{DSon} \text{ at } T_j}{R_{DSon} \text{ at } 25\ °C}$.

(1) R_{DSon} at V_{GS} = 4.5 V; I_D = 0.5 mA.
(2) R_{DSon} at V_{GS} = 2.5 V; I_D = 0.5 mA.

Fig.13 Temperature coefficient of drain-source on-resistance as a function of junction temperature; typical values.

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads **SOT23**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1 max.	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT23						97-02-28

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

NOTES

Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 160 1010,
Fax. +43 160 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 689 211, Fax. +359 2 689 102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,
Tel. +45 32 88 2636, Fax. +45 31 57 0044

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615800, Fax. +358 9 61580920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,
Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: see Singapore

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,
20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,
Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 1231,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000,
Tel. +27 11 470 5911, Fax. +27 11 470 5494

South America: Al. Vicente Pinzon, 173, 6th floor,
04547-130 SÃO PAULO, SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 3 301 6312, Fax. +34 3 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 632 2000, Fax. +46 8 632 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2686, Fax. +41 1 488 3263

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2865, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,
Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,
Tel. +90 212 279 2770, Fax. +90 212 282 6707

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381

Uruguay: see South America

Vietnam: see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,
Tel. +381 11 625 344, Fax.+381 11 635 777

For all other countries apply to: Philips Semiconductors,
International Marketing & Sales Communications, Building BE-p, P.O. Box 218,
5600 MD EINDHOVEN, The Netherlands, Fax. +31 40 27 24825

Internet: http://www.semiconductors.philips.com

Printed in The Netherlands 135108/00/04/pp12 Date of release: 1998 Feb 11 Document order number: 9397 750 03303

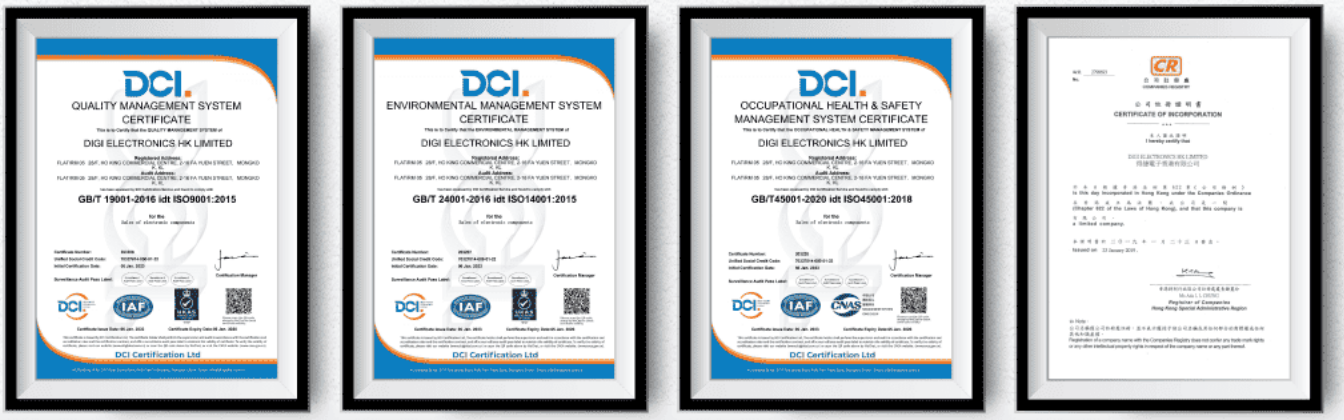
Let's make things better.

Philips Semiconductors

PHILIPS

OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.